FORM PTO-1595 (Rev. 6-93)		4 SHEET U.S. DEPARTMENT OF COMMERCE Patent and Trademark Office
OMB No. 0651-0011 (exp. 4/94)		
To the Honorable Commi		attached original documents or conv thereof
1. Name of conveying party(ies):	102908012	2. Name and address of receiving party(ies):
Hyung-Woan Koo		Name: Samsung Electronics, Co., Ltd.
		Internal Address:
Additional name(s) of conveying party(ies	s) attached?	
3. Nature of conveyance:		Street Address: 416, Maetan-dong, Yeongtong-gu,
		Suwon-si, Gyeonggi-do, Republic of Korea
🛛 Assignment	□ Merger	
Security Agreement	□ Change of Name	City: State ZIP
□ Other		
Execution Date: <u>Decemb</u>	ber 7, 2004	Additional name(s) & address attached? 🛛 Yes 🛛 No
5. Name and address of party to w	Additional numbers attached	6. Total number of applications and registrations
document should be mailed:		involved
Name: <u>Anthony P. Onello,</u> Internal Address: MILLS	Jr. & ONELLO LLP	7. Total fee (37 CFR 3.41) \$40.00
	×	⊠ Enclosed
	· · · · · · · · · · · · · · · · · · ·	□ Authorized to be charged to deposit account
Street Address: Eleven	Beacon Street, Suite 605	8. Deposit Account Number:
City: Boston	State MA ZIP 02108	(Attach duplicate copy of this page if paying by deposit account)
٠	DO NOT USE T	THIS SPACE
9. Statemen fand signature: To the best of my knowledge and a document. <u>Anthony P. Onello. Jr., Rep</u> Name of Person Signing		e and correct and any attached copy is a true copy of the original
	r of pages including cover sheet, attacl	hments, and document 3
12/20/2004 DBYRNE 00000131 11008 01 FC:8021	1532 ail documents to be recorded with re C tandais Boner for Patents, P.O. Box	equired cover sheet information to: 1450. Alexandria. VA 22313-1450.

 $J:\SAM\0669\power{PTO1595.wpd}$

PATENT REEL: 016080 FRAME: 0196

Reference No.: SAM-0669

ASSIGNMENT

I, Hyung-Woan Koo, of \$55-2 Jinan-ri, Tasan-sup, Hwasung-si, Gyeonggi-do, Republic of Korea, having invented improvements in DIFFERENTIAL SWITCHING CIRCUIT AND DIGITAL-TO-ANALOG CONVERTER, described in an application for Letters Patent of the United States, executed by mc of even date herewith, for good and valuable consideration, receipt of which is hereby acknowledged from Samsung Electronics, Co., Ltd., a Korean corporation having a place of business at 416. Meetandong, Yeongtong-gu, Suwon-si, Gyeonggi-do, Republic of Korea (and hereinafter called the Assigner, which term shall include its successors and assigns), do hereby sell, assign and transfer unto the Assigner my entire right, title, and interest in and throughout the United States of America (including its territories and dependencies) and all countries forsign thereto, in and to and under said application (which term shall include hereinafter where the context so admits all divisional, continuing, reissue and other patent applications based thereon) and the inventions (which term shall include each and every such invention, or part thereof) therein described, and any and all patents and like rights of exclusion (including extensions thereof) of any country which may be granted on or for said inventions or on said application;

And for the same consideration I do also hereby sell, assign, and transfer unto the Assignee, all my rights under the International Convention for the Protection of Industrial Property, the Patent Cooperation Treaty, and all other treaties of like purpose in respect of sold inventions and sold application, and I do hereby authorize the Assignee to apply in my name or its own name or its designee for patents and like rights of exclusion on or for sold inventions in all countries, claiming (if the Assignee so desires) the priority of the filing date of sold application under the provisions of sold Convention, Treaty or any such other Convention or Treaty;

And for the same consideration, i do horeby same for myself and for my heirs, executors, and administrators, promptly upon request of the Assignee to execute and deliver without further compensation any power of attorney, assignment, original, divisional, continuing, reizaue or other application or applications for patent or patents or like rights of exclusion of any country, or other lawful documents and any further assurances that may be doemed necessary or dusirable by the Assignee, fully to secure to it said right, title, and interest as aforesaid in and to said inventions, applications, and said several patents and like rights of exclusion (including extensions thereof) or any of them, all, however, at the expense of the Assignee, its successory, or assigns;

And I do hereby authorize and request the Commissioner of Patents and Trademarks of the United States of America and the corresponding Official of each country foreign thereto to issue to the Assignee, any and all patents and like rights of exclusion which may be granted in any country upon taid United States application on or for said inventions;

And i do hereby covenant for myself and my legal representatives and agree with the Assignee, that I have granted no right or license to make, use, or sell said inventions to anyone except the Assignee, that prior to the execution of this deed our right, title, and interest in and to said inventions has not been otherwise encumbered by me, and that I have not executed and will not execute any instruments in conflict herewith.

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First or Sole Inventor:

Signature:

Om Koo

Date: 2004/12/7

REFERENCE NO.: SAMAGE

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RECORDED: 12/09/2004